

JUL 18 2005

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PLEASE DELIVER TO EXAMINER T. PHAMDocket No. END920030018US1 (IEN-10-5765)

Applicant(s):

Serial No.	Filing Date	Examiner	Group Art Unit
<u>10/666,775</u>	<u>September 18, 2003</u>	<u>T. Pham</u>	<u>2813</u>

Invention:

METHOD OF FORMING A BOND PAD ON AN I/C CHIP AND RESULTING STRUCTURE

I hereby certify that this AMENDMENT is being transmitted via facsimile to the United States Patent and Trademark Office

Fax. No. 571-273-8300 on July 18, 2005 9
(Date) (No. of pages)

TO: Examiner Pham

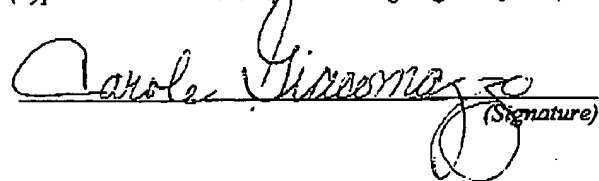
Attached is an Amendment being filed in response to your action of June 14, 2005 in the above entitled application.

It is not believed that any fees are required. However, the Commissioner is hereby authorized to charge payment of fees associated with this communication, or credit any overpayment, to Deposit Account No. 09-0457.

FROM: William N. Hogg
CUSTOMER NO. 26681

Carole Giacomazzo

(Typed or Printed Name of Person Signing Certificate)


(Signature)

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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of Biggs et al

Serial No.: 10/666,775

Filed: September 18, 2003

For: **METHOD OF FORMING A BOND PAD ON AN I/C
CHIP AND RESULTING STRUCTURE**

) Examiner: T. Pham
)
) Art Unit: 2813
)
) Confirmation No. 9436
)
)
)

Docket No. END920030018US1 (IEN-10-5765)

AMENDMENT AFTER FINAL REJECTION

Mail Stop AF
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Responsive to the Examiner's letter of June 14, 2005, it is respectfully requested that the specification and claims be amended as shown in the attached sheets; namely replace the title of the invention with the revised title, cancel withdrawn claims 1-10, cancel claims 11-13 and 15 (claim 14 having already been canceled), and amend claims 16-19.

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